L Number	Hits	Search Text	DB	Time stamp
1	311811	alkali or naoh or lioh or koh	USPAT;	2003/08/13 17:20
			US-PGPUB	
2	228775	"stainless steel"	USPAT;	2003/08/13 17:20
			US-PGPUB	
3	371041	silicon	USPAT;	2003/08/13 17:22
١	3/1041	Silicon	US-PGPUB	2000/00/10 17.22
	44400	(-11,-1;		0000/00/40 40:00
4	11429	(alkali or naoh or lioh or koh) and "stainless steel" and silicon	USPAT;	2003/08/13 16:26
			US-PGPUB	
5	885	(alkali or naoh or lioh or koh) with "stainless steel"	USPAT;	2003/08/13 16:26
			US-PGPUB	
6	211	((alkali or naoh or lioh or koh) and "stainless steel" and silicon) and ((alkali or naoh or	USPAT;	2003/08/13 16:29
		lioh or koh) with "stainless steel")	US-PGPUB	
7	238022	stainless	USPAT;	2003/08/13 16:29
			US-PGPUB	
8	211	(((alkali or nach or lich or koh) and "stainless steel" and silicon) and ((alkali or nach or	USPAT;	2003/08/13 16:30
·		lioh or koh) with "stainless steel")) and stainless	US-PGPUB	2000,00,10,10,00
9	297208	alkali or naoh or lioh or koh	EPO; JPO;	2003/08/13 17:20
*	291200	alkali di fiadii di fidii di kofi		2003/06/13 17.20
			DERWENT;	
			IBM_TDB	
10	82265	"stainless steel"	EPO; JPO;	2003/08/13 17:21
			DERWENT;	
			IBM_TDB	
11	0	((((alkali or naoh or lioh or koh) and "stainless steel" and silicon) and ((alkali or naoh or	EPO; JPO;	2003/08/13 17:21
		lioh or koh) with "stainless steel")) and stainless) and (alkali or naoh or lioh or koh)	DERWENT;	
		and "stainless steel"	IBM_TDB	
12	370331	silicon	EPO; JPO;	2003/08/13 17:22
12	370331	Silicon	DERWENT;	2003/00/13 17.22
	70		IBM_TDB	00000004047.00
13	76	(alkali or naoh or lioh or koh) and "stainless steel" and silicon	EPO; JPO;	2003/08/13 17:30
			DERWENT;	
			IBM_TDB	
14	56189	metal with ions	USPAT;	2003/08/13 17:30
			US-PGPUB	
15	9342	"stainless steel" and (metal with ions)	USPAT;	2003/08/13 17:30
			US-PGPUB	
16	172	"stainless steel" with (metal with ions)	USPAT;	2003/08/13 17:31
		- Canada Cara Cara Cara Cara Cara Cara Cara C	US-PGPUB	
17	41442	metal adj2 ions	USPAT;	2003/08/13 17:31
17	41442	Illetal aujz ions	1	2003/00/13 17.31
امدا	2750		US-PGPUB	00000004047.00
18	6753	"stainless steel" and (metal adj2 ions)	USPAT;	2003/08/13 17:32
			US-PGPUB	
19	99	"stainless steel" with (metal adj2 ions)	USPAT;	2003/08/13 17:32
			US-PGPUB	
20	99	("stainless steel" with (metal adj2 ions)) not ((alkali or naoh or lioh or koh) and	USPAT;	2003/08/13 17:32
		"stainless steel" and silicon)	US-PGPUB	
21	97	(("stainless steel" with (metal adj2 ions)) not ((alkali or nach or lich or koh) and	USPAT;	2003/08/13 17:46
		"stainless steel" and silicon)) not ((((alkali or naoh or lioh or koh) and "stainless steel"	US-PGPUB	
		and silicon) and ((alkali or naoh or lioh or koh) with "stainless steel")) and stainless)	55 . 5. 52	
22	1602556	metal	EPO; JPO;	2003/08/13 17:46
24	1002550	Illetai	DERWENT;	2003/00/13 17.40
			· ·	
			IBM_TDB	
23	125391	ions	EPO; JPO;	2003/08/13 17:46
			DERWENT;	
•			IBM_TDB	
24	526	"stainless steel" and metal and ions	EPO; JPO;	2003/08/13 17:47
,			DERWENT;	
			IBM_TDB	
25	250904	alkali	EPO; JPO;	2003/08/13 17:47
	200004	Will Seed	DERWENT;	2000,007,017,47
	00	Makintan akadi and makat and inna) and -III-II	IBM_TDB	2002/00/42 47:52
26	60	("stainless steel" and metal and ions) and alkali	EPO; JPO;	2003/08/13 17:58
			DERWENT;	i
		1	IBM_TDB	1

J	7
	•

27	247013	purify or purifying or purified	USPAT;	2003/08/13 17:58
			US-PGPUB	
28	430103	semiconductor or "integrated circuit"	USPAT;	2003/08/13 17:59
1		•	US-PGPUB	
29	1754	"stainless steel" and (purify or purifying or purified) and (semiconductor or "integrated	USPAT;	2003/08/13 17:59
		circuit")	US-PGPUB	
30	0	(alkali or naoh or lioh or koh) and ("stainless steel" and (purify or purifying or purified)	USPAT;	2003/08/13 17:59
		and (semiconductor or "integrated circuit"))	US-PGPUB	